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Vishay Siliconix

# N-Channel 200 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0152				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.0169				
Q <sub>g</sub> typ. (nC)	58				
I <sub>D</sub> (A)	90				
Configuration	Single				

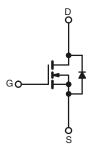
#### **FEATURES**

- ThunderFET® power MOSFET
- $\bullet$  Tuned for the lowest  $R_{DS}$   $Q_{oss}$  FOM
- Maximum 175 °C junction temperature
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



#### **APPLICATIONS**

- · Power supplies:
  - Uninterruptible power supplies
- AC/DC switch-mode power supplies
- Lighting
- · Synchronous rectification
- DC/DC converter
- · Motor drive switch
- DC/AC inverter
- · Solar micro inverter
- Class D audio amplifier



N-Channel MOSFET

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free and halogen-free	SUP90142E-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	200	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
Continuous drain current	T <sub>C</sub> = 25 °C		90		
	T <sub>C</sub> = 125 °C	l <sub>D</sub>	52		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	240	A	
Continuous source-drain diode current		I <sub>S</sub>	90		
Single pulse avalanche current a	1 0.1 ml l	I <sub>AS</sub>	60		
Single pulse avalanche energy a	e pulse avalanche energy <sup>a</sup> L = 0.1 mH		180	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C	Б	375 <sup>b</sup>	w	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	125 <sup>b</sup>	VV	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) c			260	-0	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	MAXIMUM	UNIT	
Maximum junction-to-ambient (PCB mount) c		R <sub>thJA</sub> 40		°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.4	C/VV	

#### Notes

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).
- d. Package limited.



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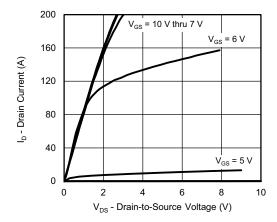
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	250	nA
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	150	
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	-	-	5	mA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	60	-	-	Α
Duning annual or state projections of	<u> </u>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A	-	0.0126	0.0152	Ω
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 30 \text{ A}$	-	0.0133	0.0169	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	-	63	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	3120	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	280	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	24	-	
Total gate charge	Qg		-	58	87	nC
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 60 \text{ A}$	-	17.6	-	
Gate-drain charge	Q <sub>gd</sub>		-	17.2	-	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	-	108	162	
Gate resistance	R <sub>g</sub>	f = 1 MHz	1.5	3	5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	14	28	
Rise time	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_L = 1.66 \Omega, I_D \cong 60 \text{ A},$	-	125	250	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	27	54	ns
Fall time	t <sub>f</sub>		-	80	150	
<b>Drain-Source Body Diode Characteristic</b>	cs					•
Pulse diode forward current (t = 100 μs)	I <sub>SM</sub>		-	-	240	Α
Body diode voltage	V <sub>SD</sub>	$I_F = 30 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.85	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>		-	150	300	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	L = 20 A dl/d+ 400 A/:-	-	0.9	1.8	nC
Reverse recovery fall time	ta	I <sub>F</sub> = 30 A, dl/dt = 100 A/μs	-	125	-	
Reverse recovery rise time	t <sub>b</sub>		-	25	-	ns
Body diode peak reverse recovery charge	I <sub>RM(REC)</sub>		-	11.5	20	Α

#### Notes

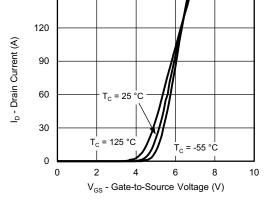
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



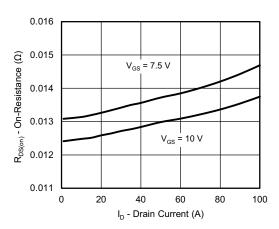


### **Output Characteristics**

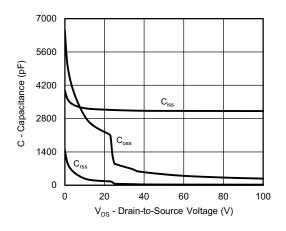


150

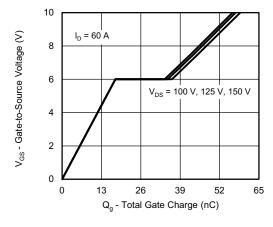
**Transfer Characteristics** 



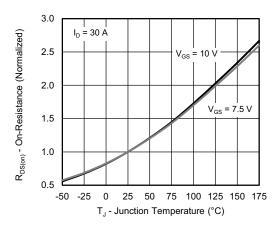
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

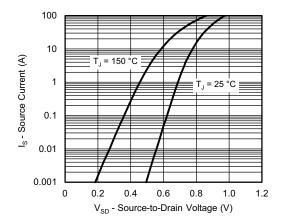


**Gate Charge** 

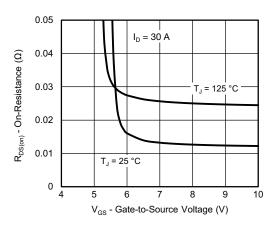


On-Resistance vs. Junction Temperature

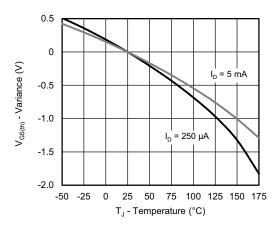




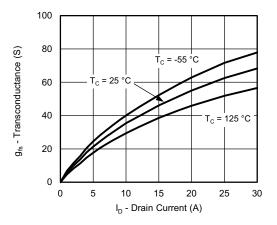
Source-Drain Diode Forward Voltage



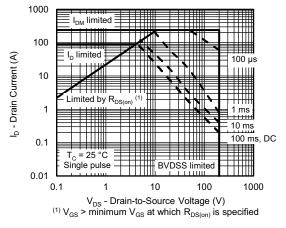
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



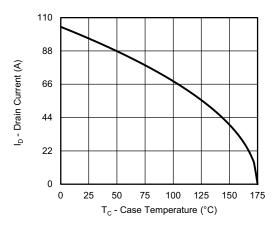
Transconductance



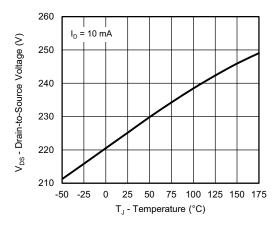
Safe Operating Area, Junction-to-Ambient

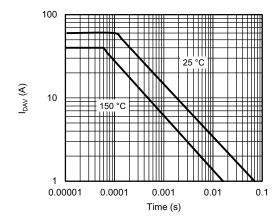
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### Current Derating a





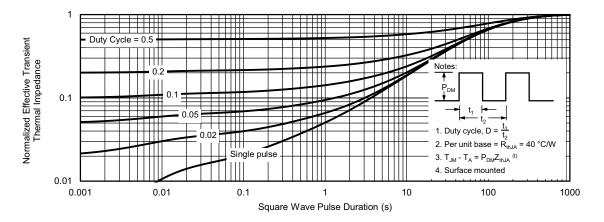
Drain Source Breakdown vs. Junction Temperature

I<sub>DAV</sub> vs. Time

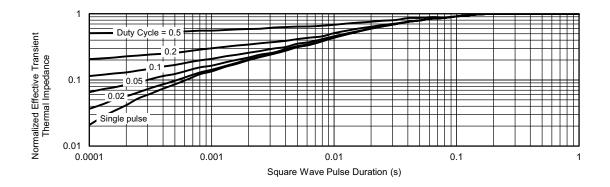
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



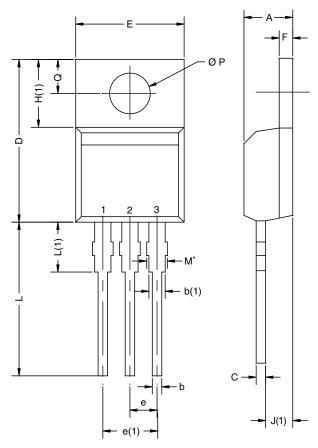
Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220AB**



		D2

	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

#### Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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